



To the Honorable Comm.

102751437

J original documents or copy thereof.

Name of conveying party(ies):

1. Markus Kirchhoff

S.24-04

(Additional name(s) of conveying party(ies) attached) Yes  No

1. Name and address of receiving party(ies):

Name: Infineon Technologies AG

Street Address: St. -Martin-Strasse 53

City: Muenchen

State: Germany

ZIP: 81669

Additional name(s) & address(es) attached  Yes  No

2. Nature of conveyance:

- Assignment  Merger
- Security Agreement  Change of Name
- Other

Execution Date: March 27, 2001

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)

09/793,345

B. Patent No.(s)

Additional numbers attached  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Lerner and Greenberg

Internal Address:

Street Address: P.O. Box 2480

City: Hollywood

State: FL

ZIP: 33022

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41) .....\$ 40.00

Enclosed

Authorized to be charged to deposit account

8. Deposit account number:

(Attach duplicate copy of this page by deposit account)

OFFICE OF PUBLIC RECORDS  
MAY 24 3 57 PM '04  
FINANCE SECTION

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

RALPH E. LOCHER  
REG. NO. 41,947

Name of Person Signing

Signature

May 18, 2004

Date

Total number of pages including cover sheet, attachments, and document:

2

Mail documents to be recorded with required cover sheet information to:

05/25/2004 LNUELLER 00000007 09793345

Mail Stop Assignment Recordation Services

01 FC:8021

40.00 DP

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

ASSIGNMENT

WHEREAS I, MARKUS KIRCHHOFF, residing at OTTENDORF-OKRILLA, Germany, have invented certain new and useful improvements in a

METHOD FOR FILLING DEPRESSIONS IN A SURFACE OF A SEMICONDUCTOR STRUCTURE, AND A SEMICONDUCTOR STRUCTURE FILLED IN THIS WAY

for which an application for Letters Patent of the United States of America was executed on the date of execution of this assignment;

WHEREAS, INFINEON TECHNOLOGIES AG, a German corporation doing business at München, Germany is desirous of acquiring the entire interest in the invention, and in any and all Letters Patent of the United States that may be obtained therefor;

NOW, THEREFORE, be it known that for and in consideration of my employment by the said corporation and other valuable consideration, the receipt and sufficiency whereof are hereby acknowledged, I have sold, assigned and transferred, and by these presents do sell, assign and transfer unto the said corporation, its legal representative, successors and assigns, the full and exclusive right to the said invention as fully set forth and described in the above-mentioned application, and to the application and any and all divisions and continuations thereof, and any and all Letters Patent of the United States which may be granted therefore, and any and all reissues of the Letters Patent, the same to be held and enjoyed by the said corporation, its legal representatives, successors and assigns, to the full end of the term for which the Letters Patent may be granted or may be reissued or extended, as fully and entirely as the same would have been held by me had this assignment and sale not been made.

AND I hereby authorize the Commissioner of Patents to issue any and all Letters Patent of the United States on the invention or resulting from the application and from any and all divisions and continuations thereof of the said corporation as the assignee of the entire right, title and interest in and to the same.

IN TESTIMONY WHEREOF, I have hereunto set my hand and seal this 27<sup>th</sup> day of March, 2001.

In the presence of:

Kathleen Liebich: L. Liebich  
Falk Odrich: F. Odrich

Markus Kirchhoff (U.S.)  
MARKUS KIRCHHOFF